

ISO9001 ISO14001 IATF16949 CHILISIN ELECTRONICS CORP. RoHS & Halogen Free & REACH Compliance.

## SPECIFICATION FOR APPROVAL

Chilisin P/N:		BDH	HDG201208	BR47MFC		
Quantity :	0	Pcs.	Date :	2020/04/16		
Drawing No :	CE1-041667					
Customer P/N:						
Customer :			DIGI-KE	Y		

	SPECIFICATION ACCEPTED BY:
COMPONENT	
ENGINEER	
ELECTRICAL	
ENGINEER	
MECHANICAL	
ENGINEER	
APPROVED	
REJECTED	

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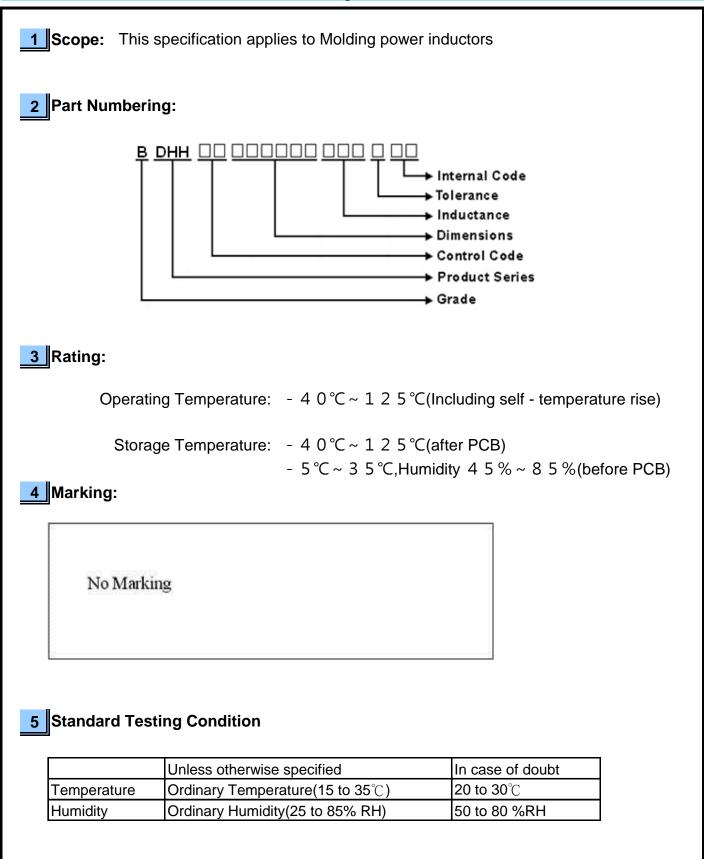
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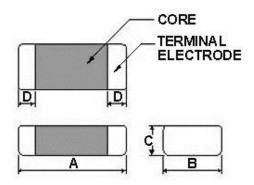
## **BDHHDG201208 Series Specification**





## **BDHHDG201208 Series Specification**

## 6 Configuration and Dimensions:



Dimensions in mm				
TYPE	201208			
А	2.0±0.2			
В	1.2±0.2			
С	0.8 Max			
D	0.5±0.3			

## 7 Electrical Characteristics:

Part No.	Inductance (uH )	Tolerance (±%)	Test Freq.	Irms(A) Max.	Isat(A) Max.	RDC(mΩ) Max.(Typ)	
BDHHDG201208R47MFC	0.47	20	2MHz,0.2V	3.7	4.3	27(23)	

#### NOTE:

1.Operating temperature range - 4 0 °C ~ 1 2 5 °C(Including self - temperature rise)

2.Isat for Inductance drop 30% from its value without current.

3.Irms for a 40°C temperature rise from 25°C ambient.

4.All test data is referenced to 25°C ambient

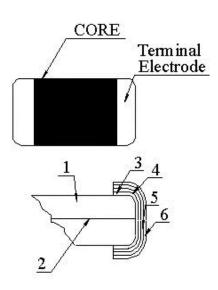
5.Absolute maximum voltage 20VDC

6. Rated current: Isat or Irms, whichever is smaller



## **BDHHDG201208 Series Specification**

## 8 BDHHDG201208 Series 8.1 Construction:



## 8.2 Material List:

No	Part	Material
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn

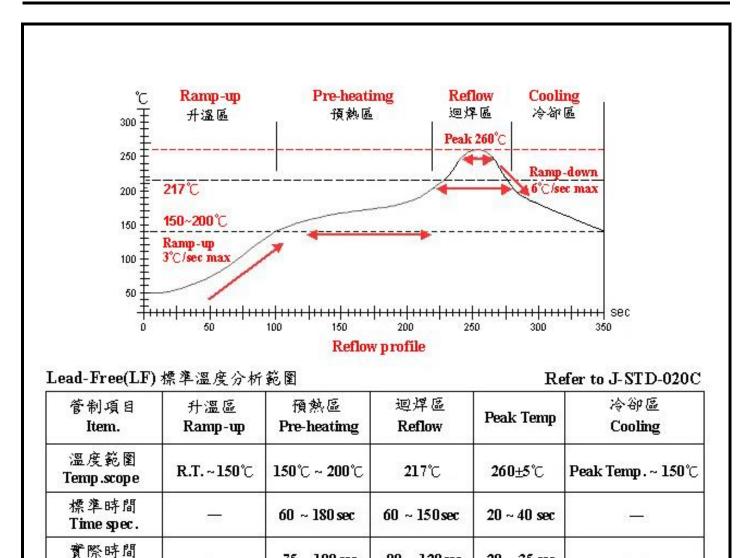


# **BDHHDG201208 Series Specification** 9 Reliability Of Molding power inductors

	lechanical Performance	Que estis estis u		Teet Methed		
No	Item	Specification		Test Method		
1-1-1	Flexure Strength	The forces applied on the right		evice shall be soldered on the sub	ostrate	
		conditions must not damage	Substr	ate Dimension: 100x40x1.6mm		
		the terminal electrode and the	Deflec	tion: 2.0mm 🔬 🕂		
		metal body	Keepir	ng Time: 30sec		
		,	•			
1-1-2	Vibration	Appearance:No damage (for	Test d	evice shall be soldered on the sub	ostrate	
		microscope of CASTOR MZ-45 20X)		tion Frequency: 10 to 55 to 10Hz		
		Inductance change shall be		ude: 1.5mm		
		within ±20%			Chro	
1 4 0	Desistance to Caldering Llast			2hrs for each axis (X, Y & Z), total	0115	
1-1-3	Resistance to Soldering Heat			ating: 150℃, 1min	- \	
		More than 75% of the terminal.		Composition: Sn/Ag3.0/Cu0.5(Pb	o-Free)	
		electrode should be covered		Temperature: 260±5℃		
		with solder.	Immer	Immersion Time: 10±1sec		
		Inductance: within ±20% of				
		initial value				
1-1-4	Solder ability	The electrodes shall be at	Pre-he	ating: 150℃, 1min		
		least 95% covered with new	Solder	Composition: Sn/Ag3.0/Cu0.5(Pb	o-Free)	
		solder coating		Temperature: 245±5℃	,	
		g		sion Time: 4±1sec		
-1-5	Terminal Strength Test	No split termination	Test d	strate		
	ronning et onger root		Test device shall be soldered on the substrate, then apply a force in the direction of the arrow.			
			Force : 5N			
				Keeping Time: 10±1sec		
		Keeping time. T0±1sec		ig fille. TOETSec		
		Mounting Pad				
	nvironmental Performance			Toot Mothed		
No	Item	Specification	0.000	Test Method		
1-2-1	Temperature Cycle	Appearance: No damage	One c			
					<b>T</b> ' / ' \	
		Inductance:within±20% of	Step	Temperature (°C)	Time (min)	
		Inductance:within±20% of initial value	1	-40±3	30	
			1	-40±3	30	
			1	-40±3 25±2	30 3	
			1 2 3 4	-40±3 25±2 125±3	30 3 30	
			1 2 3 4 Total:	-40±3 25±2 125±3 25±2 100cycles	30 3 30 30 3	
1-2-2	Humidity Resistance		1 2 3 4 Total: Measu	-40±3 25±2 125±3 25±2 100cycles ired after exposure in the room co	30 3 30 30 3	
1-2-2	Humidity Resistance		1 2 3 4 Total: Measu Tempe	$-40\pm3$ $25\pm2$ $125\pm3$ $25\pm2$ 100cycles ured after exposure in the room constrature: $60\pm2^{\circ}C$	30 3 30 3 3 ndition for 24hrs	
1-2-2	Humidity Resistance		1 2 3 4 Total: Measu Tempe Relativ	-40±3 25±2 125±3 25±2 100cycles ired after exposure in the room col erature: 60±2°C /e Humidity: 90 ~ 95% / Time: 500	30 3 30 3 ndition for 24hrs	
	-		1 2 3 Total: Measu Tempe Relativ Measu	-40±3 25±2 125±3 25±2 100cycles ired after exposure in the room concernature: 60±2°C ve Humidity: 90 ~ 95% / Time: 500 ired after exposure in the room concord	30 3 30 3 ndition for 24hrs	
	High		1 2 3 4 Total: Measu Relativ Measu Tempe	$-40\pm3$ $25\pm2$ $125\pm3$ $25\pm2$ 100cycles ured after exposure in the room constrature: $60\pm2^{\circ}C$ //e Humidity: 90 ~ 95% / Time: 500 ured after exposure in the room constrature: $85\pm3^{\circ}C$	30 3 30 3 ndition for 24hrs	
	-		1 2 3 4 Total: Measu Relativ Measu Tempe Relativ	-40±3 25±2 125±3 25±2 100cycles ared after exposure in the room con- parature: $60\pm2^{\circ}C$ we Humidity: 90 ~ 95% / Time: 500 ared after exposure in the room con- parature: $85\pm3^{\circ}C$ we Humidity: 0% / Time: 500hrs	30 3 30 3 ndition for 24hrs hrs ndition for 24hrs	
1-2-3	High Temperature Resistance		1 2 3 4 Total: Measu Relativ Measu Relativ Measu	-40±3 25±2 125±3 25±2 100cycles red after exposure in the room con- erature: 60±2°C /e Humidity: 90 ~ 95% / Time: 500 red after exposure in the room con- erature: 85±3°C /e Humidity: 0% / Time: 500hrs ired after exposure in the room con-	30 3 30 3 ndition for 24hrs hrs ndition for 24hrs	
1-2-3	High Temperature Resistance		1 2 3 4 Total: Measu Relativ Measu Relativ Measu	-40±3 25±2 125±3 25±2 100cycles ared after exposure in the room con- parature: $60\pm2^{\circ}C$ we Humidity: 90 ~ 95% / Time: 500 ared after exposure in the room con- parature: $85\pm3^{\circ}C$ we Humidity: 0% / Time: 500hrs	30 3 30 3 ndition for 24hrs hrs ndition for 24hrs	
	High Temperature Resistance		1 2 3 4 Total: Measu Relativ Measu Tempe Relativ Measu Tempe	-40±3 25±2 125±3 25±2 100cycles red after exposure in the room con- erature: 60±2°C /e Humidity: 90 ~ 95% / Time: 500 red after exposure in the room con- erature: 85±3°C /e Humidity: 0% / Time: 500hrs ired after exposure in the room con-	30 3 30 3 ndition for 24hrs hrs ndition for 24hrs	



## **BDHHDG201208 Series Specification**



Time result

NOTE :

1. Re-flow possible times : within 2 times

2. Nitrogen adopted is recommended while in re-flow

75 ~ 100 sec

90 ~ 120 sec

20 ~ 35 sec

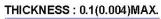


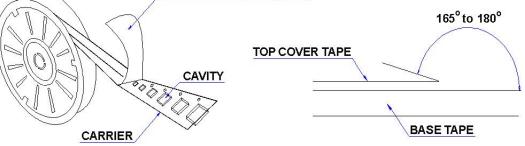
## **BDHHDG201208 Series Specification**

## 10 Packaging:

## 10.1 Packaging -Cover Tape

The force for tearing off cover tape is 10 to 100 grams in the arrow direction.

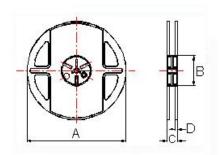




## **10.2 Packaging Quantity**

TYPE	PCS/REEL
201208	3000

## **10.3 Reel Dimensions**



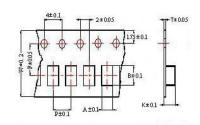
TYPE	А	В	С	D
201208	178	60	12	1.5

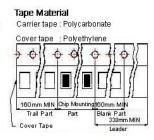


## **BDHHDG201208 Series Specification**

## 10 Packaging:

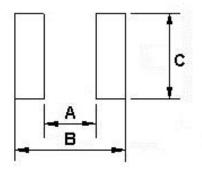
## 10.4 Tape Dimensions in mm





TYPE	А	В	Т	W	Р	F	K
201208	1.45	2.25	0.22	8	4	3.5	1.04

## 11 Recommended Land Pattern:



#### Dimensions in mm

TYPE	А	В	С
201208	0.8~1.2	2.3~2.9	1.0~1.45

## 12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5.After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.



## **BDHHDG201208 Series Specification**

13 Graph: BDHHDG201208R47MFC 0.60 50 0.50 40 0.40 30 Ĥ\_\_\_\_ 0.30 ∆T(°O) 20 0.20 L(uH) 10 0.10 ΔT(°C) 0.00 0 3 0.5 0 1 1.5 2 2.5 3.5 4 4.5 DC Current(A)